

JIANGSU CHANGJING ELECTRONICS TECHNOLOGY CO., LTD

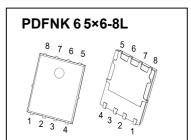
PDFNK 65×6-8L Plastic-Encapsulate MOSFETS

CJAC130SN04L N-Channel Power MOSFET

V _{(BR)DSS}	R _{DS(on)} TYP	I _D
40 V	2.0mΩ@10V	130A

DESCRIPTION

These N-Channel enhancement mode power field effect transistors are using SGT technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.



FEATURES

- Battery switch
- Load switch
- High density cell design for ultra low R_{DS(ON)}
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

APPLICATIONS

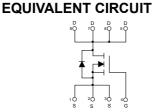
- Networking
- Load Switch

LED applications

MARKING



CJAC130SN04L = Part No. Solid dot=Pin1 indicator. XX=Code.



MAXIMUM RATINGS (T_a=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D ^①	130	Α
Continuous Drain Current (T _C =100 °C)	I _D	90	Α
Pulsed Drain Current	I _{DM} ²	390	Α
Single Pulsed Avalanche Energy	E _{AS}	300	mJ
Power Dissipation	$P_D^{\scriptscriptstyle{\textcircled{1}}}$	120	W
Thermal Resistance from Junction to Ambient	R _{θJA} [®]	62.5	°C/W
Thermal Resistance from Junction to Case	R _{eJC} ^①	1.04	°C/W
Operating Junction and Storage Temperature Range	T _J ,T _{stg}	-55~+150	℃

MOSFET ELECTRICAL CHARACTERISTICS

T_a=25 ℃ unless otherwise specified

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
Off characteristics							
Drain-source breakdown voltage	V(BR) DSS	V _G S = 0V, I _D	=250µA	40			V
		V _{DS} =32V,	T _J =25 ℃			1.0	
Zero gate voltage drain current	I _{DSS}	Vgs =0V	T _J =125℃			100	μA
Gate-body leakage current	I _{GSS}	V _{DS} =0V, V _G	s =±20V			±100	nA
On characteristics ^④							
Gate-threshold voltage	V _G S(th)	V _{DS} =V _{GS} , I _D	=250µA	1.0	1.5	2.0	V
Statia drain agurag en agte registence	RDS(on)	Vgs =10V, Ic	=20A		2.0	2.4	mΩ
Static drain-source on-sate resistance	RDS(on)	V _{GS} =4.5V, I	D=20A		2.9	3.7	mΩ
Forward transconductance	g _{FS}	V _{DS} =5V, I _D :	=20A		43		S
Dynamic characteristics ^{① ⑤}							
Input capacitance	C _{iss}	V _{DS} =20V,V _{GS} =0V, f =1MHz			2620		pF
Output capacitance	C _{oss}				690		
Reverse transfer capacitance	C _{rss}	1 - 11VII 12		26			
Switching characteristics (4) (5)	•	•		-			*
Total gate charge	Qg				47.7		
Gate-source charge	Q_{gs}	V _{GS} =10V, V _I I _D =70A	_{DS} =20V,		6		nC
Gate-drain charge	Q_{gd}				1.2		
Turn-on delay time	t _{d(on)}				8		
Turn-on rise time	tr	V _{DS} =20V,I _D =	:35A,		30]
Turn-off delay time	td(off)	V _{GS} =10V,R _G	=1.6Ω		32		ns
Turn-off fall time	tf	-			6		
Drain-Source Diode Characteristics							
Reverse Recovery Time	trr				47		ns
Reverse Recovery Charge	Qrr	I _{SD} =30A, dI _{SD} /dt=100A/μs			35		nC
Drain-source diode forward voltage	V _{SD} ⁴	V _{GS} =0V, I _S =	:10A			1.2	V
Continuous drain-source diode forward current	Is ^①					130	А
Pulsed drain-source diode forward current	I _{SM} ^②					390	Α

Notes:

^{1.}T_C=25 $^{\circ}$ Limited only by maximum temperature allowed.

^{2.}PW≤10µs, Duty cycle≤1%.

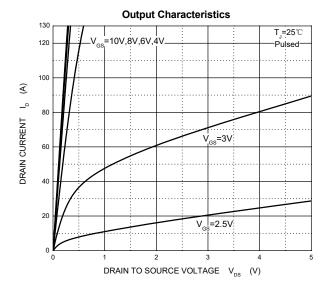
^{3.}EAS condition: VDD=25V,VGS=10V, L=0.5mH, Rg=25 Ω Starting TJ = 25 $^{\circ}$ C .

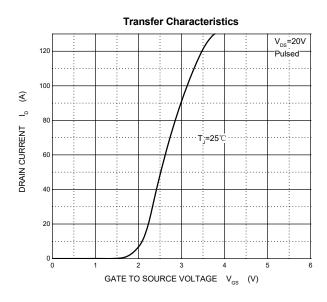
^{4.}Pulse Test : Pulse Width≤300µs, duty cycle ≤2%.

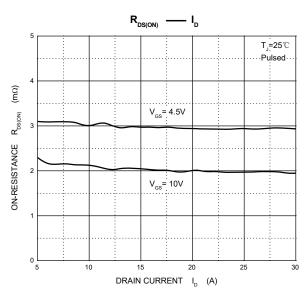
^{5.} Guaranteed by design, not subject to production.

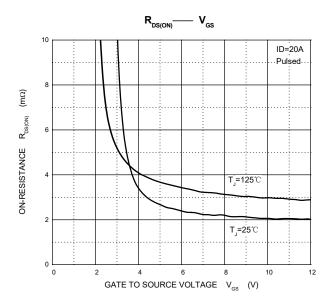
^{6.} The value of R $_{\theta}$ JA is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_a =25 $^{\circ}$ C.

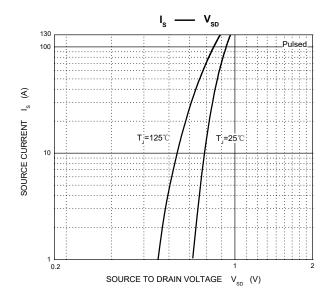
Typical Characteristics

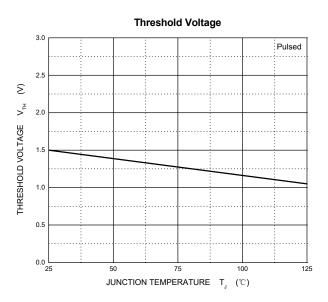




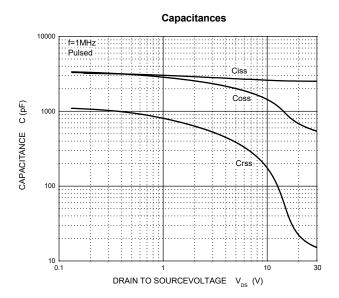


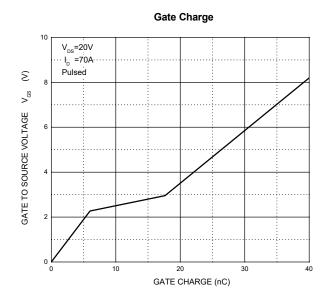


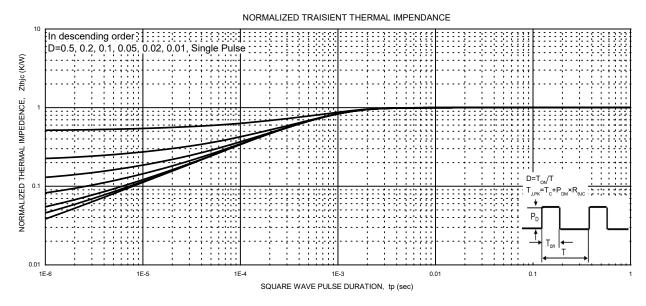


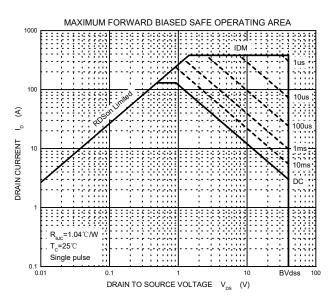


Typical Characteristics

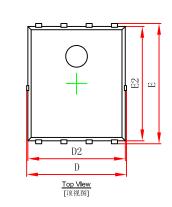




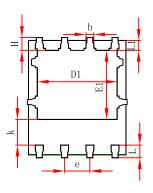




PDFNWB5x6-8L Package Outline Dimensions





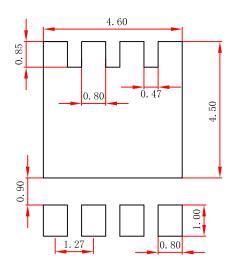


Bottom View [背视图]

		A3
Į.		
0	,	+
	Side View [侧视图]	

Completed	Dimensions I	n Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	0.900	1.000	0.035	0.039
A3	0.254	REF.	0.010	REF.
D	4.944	5.096	0.195	0.201
Е	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	k 1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
е	1.270	TYP.	0.050	TYP.
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
Н	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°

PDFNWB5x6-8L Suggested Pad Layout



Note:

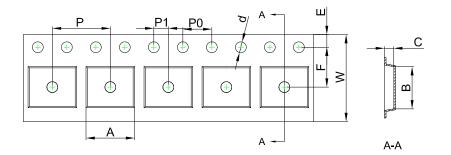
- 1. Controlling dimension:in millimeters.
- 2.General tolerance:±0.05mm.
- 3. The pad layout is for reference purposes only.

NOTICE

JSCJ reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JSCJ does not assume any liability arising out of the application or use of any product described herein.

PDFNWB5×6 Tape and Reel

PDFNWB5×6-8L Embossed Carrier Tape

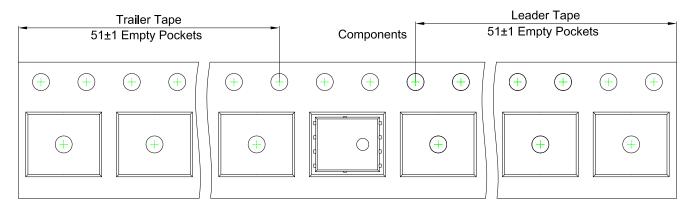


Packaging Description:

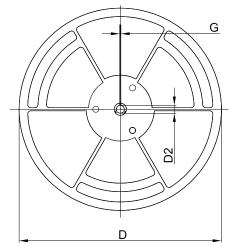
PDFNWB5×6-8L parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 5,000 units per 13" or 33.0 cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

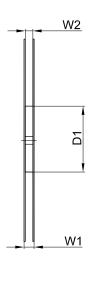
Dimensions are in millimeter										
Pkg type A B C d E F							P0	Р	P1	W
PDFNWB5×6-8L	6.30	5.30	1.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

PDFNWB5×6-8L Tape Leader and Trailer









Dimensions are in millimeter							
Reel Option	D	D1	D2	G	W1	W2	
13"Dia	Ø330.00	100.00	13.00	1.90	17.60	12.40	

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	
5,000 pcs	13 inch	5,000 pcs	340×336×29	50,000 pcs	353×346×365	